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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/720,623	11/24/2003	Joseph P. Miller	200304072-3	4259
22879	7590 04/05/2006		EXAMINER	
112 22	PACKARD COMPA	DINH, TUAN T		
P O BOX 272400, 3404 E. HARMONY ROAD INTELLECTUAL PROPERTY ADMINISTRATION			ART UNIT	PAPER NUMBER
FORT COLLINS, CO 80527-2400			2841	
			DATE MAILED: 04/05/2006	

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)			
`	10/720,623	MILLER ET AL.			
Office Action Summary	Examiner	Art Unit			
	Tuan T. Dinh	2841			
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the c	orrespondence address			
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication. - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).					
Status					
Responsive to communication(s) filed on <u>20 Ja</u> This action is FINAL . 2b) ☑ This Since this application is in condition for allowan closed in accordance with the practice under E.	action is non-final. ice except for formal matters, pro	·			
Disposition of Claims					
4) Claim(s) 1-26 and 34-39 is/are pending in the a 4a) Of the above claim(s) 1-14 is/are withdrawn 5) Claim(s) is/are allowed. 6) Claim(s) 15-26 and 34-39 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/or	from consideration.				
Application Papers		•			
9) The specification is objected to by the Examiner.					
10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.					
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).					
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d). 11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.					
Priority under 35 U.S.C. § 119					
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority documents 2. Certified copies of the priority documents 3. Copies of the certified copies of the priori application from the International Bureau * See the attached detailed Office action for a list of	have been received. have been received in Application ty documents have been receive (PCT Rule 17.2(a)).	on No d in this National Stage			
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date 11/24/03	4) Interview Summary (Paper No(s)/Mail Dal 5) Notice of Informal Pa 6) Other:	te			

DETAILED ACTION

Election/Restrictions

1. Applicant's election with traverse of Group II (claims 15-26, and 34-39) in the reply filed on 01/20/06 is acknowledged. The traversal is on the ground(s) that Groups I and II are co-extensive and no burden on the examiner in searching. This is not found persuasive because Group I is claimed as a printed circuit board structure, and would not require to be used in a computer, and Group II is claimed a system specific on the computer utility, so Group II and I would be classified in different search.

The requirement is still deemed proper and is therefore made FINAL. Claims 114 are withdrawn from further consideration as being drawn to non-elected subject matter.

Drawings

2. The drawings are objected to under 37 CFR 1.83(a). The drawings must show every feature of the invention specified in the claims. Therefore, the "<u>first, second, and third interfaces</u>, for example claim 15" must be shown or the feature(s) canceled from the claim(s). No new matter should be entered.

Corrected drawing sheets in compliance with 37 CFR 1.121(d) are required in reply to the Office action to avoid abandonment of the application. Any amended replacement drawing sheet should include all of the figures appearing on the immediate prior version of the sheet, even if only one figure is being amended. The figure or figure number of an amended drawing should not be labeled as "amended." If a drawing figure

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is to be canceled, the appropriate figure must be removed from the replacement sheet, and where necessary, the remaining figures must be renumbered and appropriate changes made to the brief description of the several views of the drawings for consistency. Additional replacement sheets may be necessary to show the renumbering of the remaining figures. Each drawing sheet submitted after the filing date of an application must be labeled in the top margin as either "Replacement Sheet" or "New Sheet" pursuant to 37 CFR 1.121(d). If the changes are not accepted by the examiner, the applicant will be notified and informed of any required corrective action in the next Office action. The objection to the drawings will not be held in abeyance.

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Claim Rejections - 35 USC § 112

- 3. The following is a quotation of the second paragraph of 35 U.S.C. 112:
 The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.
- 4. Claims 15, 35 are rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.

Regarding claim 15, line 3 and claim 35, line 2, it is unclear. The phrase of "a first set of traces or traces (claim 35) at least partially free of termination components" is not understood. Does applicant mean of "a first set of traces and at least partially free of termination components" or "a first set of traces having at least partially free formed of termination components"

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By applying art, examiner assumes the limitation would be read as "a first set of traces or traces".

Claim Rejections - 35 USC § 103

- 5. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 6. Claims 15-26, and 34-39 are rejected under 35 U.S.C. 103(a) as being unpatentable over Begis (U.S. Patent 5,610, 801) in view of Klaser (U.S. Patent 4,870,746).

As to claims 15-23, 25, Begis discloses a system (a motherboard assembly 10) as shown in figures 1-2 for a computer system (column 1, line 17) comprising a circuit board, which is a motherboard (12, column 2, lines 20-22), the motherboard (12) comprising: a first interface (pad) coupled to a first set of traces (column 2, lines 24-26, and the motherboard inherently including pad and traces, wiring, or circuitries for electrical connection to a daughterboard or components mounted on the motherboard)., and an interstitial circuit board (24, column 2, lines 40, 44) comprising a second interface (pads or lands) coupled to the first interface (pad of the motherboard), a second set of traces (column 2, lines 42-43), and a third interface (pads or lands on a top surface of the daughterboard 24 electrically couple to an integrated circuit device, which is a processor, controller, or memory controller (26). Begis further discloses the

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interstice board having multilayer including a power ad ground planes (column 2, lines 42-44).

Begis does not specific disclose the second set of traces having a plurality of termination components comprise a resistor disposed in multilevel of the interstice circuit board.

Klaser shows a multiplayer circuit board (8) having surface mount resistors (16) embedded within the interior of the multiplayer circuit board (8) disclosed in figures 1-2, and 4.

It would have been obvious to one having ordinary skill in the art at the time the invention was made to have teaching of Klaser to employ the apparatus of Begis in order to provide a laminated structure of bonding layers together to form a multilayer circuit board and also provide a resistance value on each of bonding layers to form an impedance value of the multiplayer circuit board.

As to claim 24, Begis discloses the apparatus as shown in figures 1-2 wherein the second member (24) has a substantially smaller footprint area than the motherboard (12).

As to claim 26, Begis discloses a system (a motherboard assembly 10) as shown in figures 1-2) comprising a circuit board, which is a motherboard (12, column 2, lines 20-22), the motherboard (12) comprising: a first interface (pad) coupled to a first set of traces (column 2, lines 24-26, and a second circuit board (24, column 2, lines 40, 44) comprising a second interface (pads or lands) coupled to the first interface (pad of the motherboard), a second set of traces (column 2, lines 42-43), and a third interface (pads

or lands on a top surface of the daughterboard 24 electrically couple to an integrated circuit device (26).

Begis does not specific disclose the second traces comprising mean for reducing signal degradation.

Klaser shows a multiplayer circuit board (8) having surface mount resistors (16) embedded within the interior of the multiplayer circuit board (8) disclosed in figures 1-2, and 4.

It would have been obvious to one having ordinary skill in the art at the time the invention was made to have teaching of Klaser to employ the apparatus of Begis in order to reduce noise signals.

As to claims 34-39, Begis discloses a system (a motherboard assembly 10) as shown in figures 1-2 comprising an IC (a processor 22) having a first interface (pads or lands), and an interstitial circuit board (24, column 2, lines 40, 44) comprising a second interface (pads or lands) coupled to the first interface (pads of the IC 26), a second set of traces (column 2, lines 42-43), and a third interface (pads or lands on a bottom surface of the daughterboard 24) electrically couple to a circuit board (12), which is a processor, controller, or memory controller (26). Begis further discloses the interstice board having multilayer including a power ad ground planes (column 2, lines 42-44).

Begis does not specific disclose the second set of traces having a plurality of termination components comprise a resistor disposed in multilevel of the interstice circuit board.

Klaser shows a multiplayer circuit board (8) having surface mount resistors (16) embedded within the interior of the multiplayer circuit board (8) disclosed in figures 1-2, and 4.

It would have been obvious to one having ordinary skill in the art at the time the invention was made to have teaching of Klaser to employ the apparatus of Begis in order to provide a laminated structure of bonding layers together to form a multilayer circuit board and also provide a resistance value on each of bonding layers to form an impedance value of the multiplayer circuit board.

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Tuan T. Dinh whose telephone number is 571-272-1929. The examiner can normally be reached on M-F.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Kammie Cuneo can be reached on 571-272-1957. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

well

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Tuan Dinh

March 30, 2006.